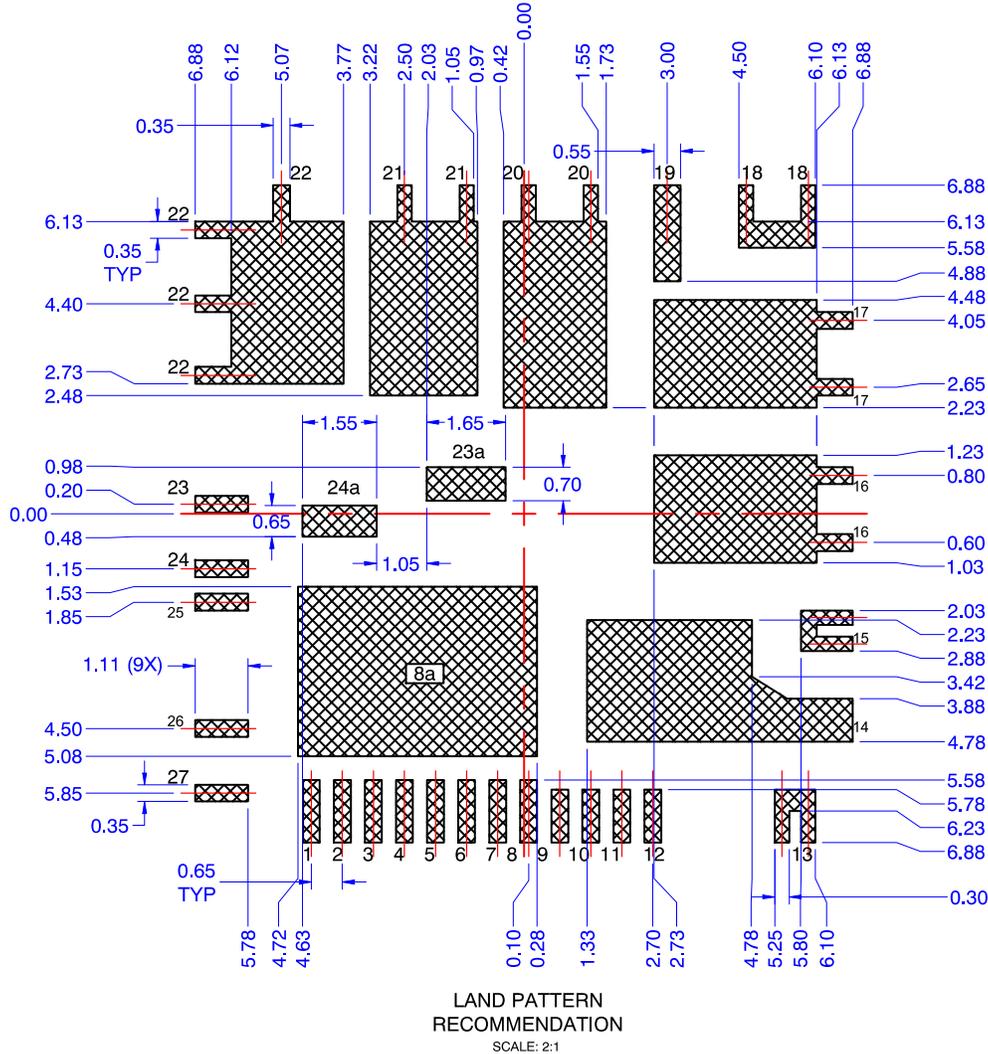


PQFN27 12.9X12.9, 0.65P
CASE 483AD
ISSUE O

DATE 30 SEP 2016



- NOTES: UNLESS OTHERWISE SPECIFIED
- A) THIS PACKAGE IS NOT PRESENTLY REGISTERED TO ANY STANDARD COMMITTEE.
 - B) DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH. MOLD FLASH OR BURRS DOES NOT EXCEED 0.10MM.
 - C) ALL DIMENSIONS ARE IN MILLIMETERS.
 - D) DRAWING CONFORMS TO ASME Y14.5M-1994.
 - E) LAND PATTERN REFERENCE:
 QFN65P1290X1290X140-40N-40N
 - F) IT IS NOT NECESSARY TO SOLDER 23a AND 24a, AND CAN BE OMITTED FROM THE FOOTPRINT

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STATUS:	ON SEMICONDUCTOR STANDARD	
NEW STANDARD:		
DESCRIPTION:	PQFN27 12.9X12.9, 0.65P	PAGE 2 OF 3

